PCN Number:		20200128006		PCN Date:	Jan. 31, 2020				
Title: Datasheet fo		r TAS5760M-Q1			·				
Customer Contact:		PCN Manage	er		Dept:			Quality Services	
Chang	е Туре:				•				
Assembly Site				Design			Wafer	Bump Site	
Assembly Process			\boxtimes	Data Sheet				Bump Material	
Assembly Materials				Part number change			Wafer	Bump Process	
Mechanical Specification				Test Site			Wafer	Fab Site	
Packing/Shipping/La		Labeling		Test Process				Fab Materials	
					Wafer	Fab Process			
Notification Details									
Description of Change:									
Texas Instruments Incorporated is announcing an information only notification.									
				ated as summarized below.					
The following change history provides further details.									
₹i a Ţi	XAS							TAREFORM OA	
INSTRUMENTS TAS5760M-Q SLOS988B – SEPTEMBER 2017 – REVISED NOVEMBER 2011									
Changes	from Revision A (.	July 2018) to Re	visi	F11100173**		JEI	TEMBER 2	Page	
Changes from Revision A (July 2018) to Revision B Page									
				o +125°C					
	 Changed Features list item, Audio Performance From: R_{LOAD} = 8Ω To: R_{SPK} = 8Ω								
 Adde 									
Added HBM and CDM classification levels to the ESD Ratings									
 Chan 	 Changed Note 2 From: JEDEC Standard 4 Layer Board To: JEDEC Standard 2 Layer Board in the Thermal Information. 5 								
Deleted the 48-pin packaged from the Thermal Information									
Changed the Stereo BTL Using Software Control to remove the 48-Pin information									
 Chan 									
Changed the Mono PBTL Using Software Control to remove the 48-Pin information									
Changed the Mono PBTL Using Hardware Control to remove the 48-Pin information									
				TL images from the Layout Example					
	•			, ,					
The datasheet number will be changing.									
	Family	•		Change From:		Change To:			
,				SLOS988A		SLOS988B			
TAS5760M-Q1 SLOS988A SLOS988B									
These changes may be reviewed at the datasheet links provided.									
http://	www.ti.com/pro	duct/TACE76	ΩМ	01					
http://www.ti.com/product/TAS5760M-Q1									
Reason for Change:									
To accurately reflect device characteristics.									
Anticip	ated impact o	n Fit, Form,	Fu	ınction, Quality or Relial	bil	ity	(posi	itive / negative):	
				cation change announceme					
	actual device.	15 a spe	J111	canon change announceme		. JI	,	c. c are no changes	
Changes to product identification resulting from this PCN:									
None.									
Produc	t Affected:								
TAS57	TAS5760MTDAPQ1 TAS5760MTDAPRQ1								
	<u> </u>			<u> </u>			<u> </u>		

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

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